

1. Description

The UMW SN74LVC2G17 is a high performance dual buffer operating from a 1.65 to 5.5V supply. At $V_{CC}=3.0V$, high impedance TTL compatible inputs significantly reduce current loading to input drivers while the TTL compatible outputs offer improved switching noise performance.

2.2 Features

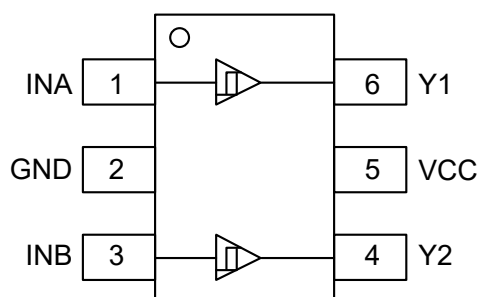
- 24mA Balanced Output Sink and Source Capability at $V_{CC}=3.0V$
- Near Zero Static Supply Current Substantially
- Reduces System Power Requirements
- Chip Complexity: FET=72; Equivalent Gate=18

2.1 Features

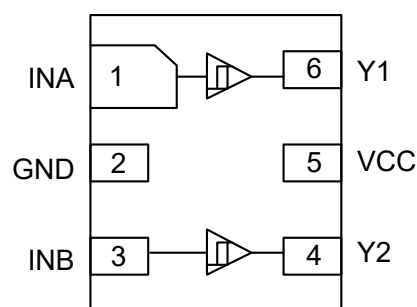
- Extremely High Speed: t_{PD} 2.0ns (typical) at $V_{CC}=5.0V$
- Designed for 1.65V to 5.5V V_{CC} Operation
- Overvoltage Tolerant Inputs
- LVTTTL Compatible – Interface Capability with 5.0V TTL Logic with $V_{CC}=3.0V$ (2.7–3.3)
- LVCMOS Compatible

- These Devices are Pb-Free and are RoHS Compliant
- NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable

3. Pinning information



SOT23-6/SC70-6



DFN6

Figure1. Top View



4.Pin Function

Pin	Function
1	INA
2	GND
3	INB
4	Y2
5	VCC
6	Y1

5.Block Diagram

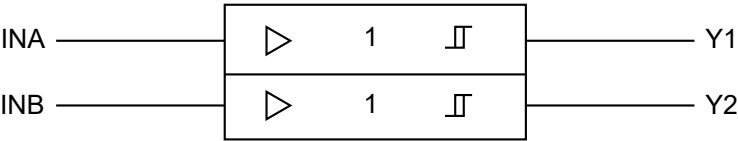


Figure2. Logic Symbol

Function Table

Input	Output
A	Y
L	L
H	H



6. Absolute Maximum Ratings

Parameter		Symbol	Value	Units
DC Supply Voltage		V_{CC}	-0.5 to 7	V
DC Input Voltage		V_I	$-0.5 \leq V_I \leq 7$	V
DC Output Voltage Output in Higher or Low State (Note 1)		V_O	-0.5 to $V_{CC} + 0.5$	V
DC Input Diode Current $V_I < GND$		I_{IK}	-50	mA
DC Output Diode Current $V_O < GND, V_O > V_{CC}$		I_{OK}	± 50	mA
DC Output Sink Current		I_O	± 50	mA
DC Supply Current per Supply Pin		I_{CC}	± 100	mA
Storage Temperature Range		T_{STG}	-65 to 150	°C
Lead Temperature, 1 mm from Case for 10 Seconds		T_L	260	°C
Junction Temperature Under Bias		T_J	150	°C
Thermal Resistance		θ_{JA}	333	°C/W
Power Dissipation in Still Air at 85°C		P_D	200	mW
Moisture Sensitivity		MSL	Level 1	
Flammability Rating Oxygen Index: 28 to 34		F_R	UL94V-0@0.12in	
ESD Classification Human	Body Model (Note 2)	ESD	2000	V
	Machine Model (Note 3)		200	V
	Charged Device Model (Note 4)		N/A	V
Latchup Performance Above V_{CC} and Below GND at 125°C (Note 5)		$I_{Latchup}$	± 100	mA

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. IO absolute maximum rating must be observed.
2. Tested to EIA/JESD22—A114—A, rated to EIA/JESD22—A114—B.
3. Tested to EIA/JESD22—A115—A, rated to EIA/JESD22—A115—A.
4. Tested to JESD22—C101—A.
5. Tested to EIA/JESD78.



7.Recommended Operating Conditions

Parameter	Symbol	Min	Max	Unit
DC Supply Voltage Operating	V_{CC}	1.65	5.5	V
Data Retention		1.5	5.5	V
DC Input Voltage	V_{IN}	0	5.5	V
DC Output Voltage (High or Low State)	V_{OUT}	0	5.5	V
Operating Temperature Range	T_A	-55	125	°C

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended.



8.DC Electrical Characteristics

Parameter	Condition	Symbol	$V_{CC}(V)$	$T_A=25^{\circ}C$			$-40^{\circ}C \leq T_A \leq 125^{\circ}C$		Units
				Min	Typ	Max	Min	Max	
Positive-going Input Threshold Voltage		V_{T+}	1.65	0.7		1.4	0.7	1.4	V
			2.3	1		1.7	1	1.7	
			3	1.3		2.0	1.3	2.0	
			4.5	1.9		3.1	1.9	3.1	
			5.5	2.2		3.7	2.2	3.7	
Negative-going Input Threshold Voltage		V_{T-}	1.65	0.3		0.7	0.3	0.7	V
			2.3	0.4		1	0.4	1	
			3	0.8		1.3	0.8	1.3	
			4.5	1.1		2	1.1	2	
			5.5	1.4		2.5	1.4	2.5	
Hysteresis ($V_{T+} - V_{T-}$)		ΔV_T	1.65	0.3		0.8	0.3	0.8	V
			2.3	0.4		0.9	0.35	0.9	
			3	0.4		1.1	0.4	1.1	
			4.5	0.6		1.3	0.6	1.3	
			5.5	0.7		1.4	0.7	1.4	
High-Level Output Voltage $V_{IN}=V_{IL}$	$I_{OH}=-100\mu A$	V_{OH}	1.65 to 5.5	$V_{CC}-0.1$	V_{CC}		$V_{CC}-0.1$		V
	$I_{OH}=-3mA$		1.65	1.29	1.52		1.29		
	$I_{OH}=-8mA$		2.3	1.9	2.1		1.9		
	$I_{OH}=-12mA$		2.7	2.2	2.4		2.2		
	$I_{OH}=-16mA$		3	2.4	2.7		2.4		
	$I_{OH}=-24mA$		3	2.3	2.5		2.3		
	$I_{OH}=-32mA$		4.5	3.8	4		3.8		



Parameter	Condition	Symbol	$V_{CC}(V)$	$T_A=25^{\circ}C$			$-40^{\circ}C \leq T_A \leq 125^{\circ}C$		Units
				Min	Typ	Max	Min	Max	
Low-Level Output Voltage $V_{IN}=V_{IH}$	$I_{OH}=100\mu A$	V_{OL}	1.65 to 5.5		0.0	0.1		0.1	V
	$I_{OL}=3mA$		1.65		0.08	0.24		0.24	
	$I_{OL}=8mA$		2.3		0.2	0.3		0.3	
	$I_{OL}=12mA$		2.7		0.22	0.4		0.4	
	$I_{OL}=16mA$		3		0.28	0.4		0.4	
	$I_{OL}=24mA$		3		0.38	0.55		0.55	
	$I_{OL}=32mA$		4.5		0.42	0.55		0.55	
Input Leakage Current	$V_{IN}=5.5V$ or GND	I_{IN}	0 to 5.5		± 0.1			± 1	μA
Power Off Leakage Current	$V_{IN}=5.5V$ or $V_{OUT}=5.5V$	I_{OFF}	0			1		10	
Quiescent Supply Current	$V_{IN}=5.5V$ or GND	I_{CC}	5.5			1		10	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.



9.AC Electrical Characteristics

Parameter	Condition	Symbol	V _{CC} (V)	T _A =25°C			-55°C≤T _A ≤125°C		Units
				Min	Typ	Max	Min	Max	
Propagation Delay (Figure 3 and 4)	R _L =1MΩ, C _L =15pF	t _{PLH} , t _{PHL}	1.65	2	5.3	11.4	2	12	ns
			1.8	2	4.4	9.5	2	10	
			2.5±0.2	0.2	3.5	6.5	0.8	4.1	
			3.3±0.3	0.8	2.1	4.5	0.5	3.7	
	R _L =500Ω, C _L =50pF		3.3±0.3	1.2	2.9	5.5	1.5	5.2	
	R _L =1MΩ, C _L =15pF		5.0±0.5	0.5	1.8	3.9	0.5	4.1	
	R _L =500Ω, C _L =50pF		5.0±0.5	0.8	2.4	4.3	0.8	4.5	

10.Capacitance Characteristics

Parameter	Symbol	Condition	Typ	Units
Input Capacitance	C _{IN}	V _{CC} =5.5V, V _I = 0V or V _{CC}	>2.5	pF
Power Dissipation Capacitance ⁽⁶⁾	C _{PD}	10MHz, V _{CC} =3.3V, V _I =0V or V _{CC}	19	pF
		10MHz, V _{CC} =5.5V, V _I =0V or V _{CC}	21	pF

Notes 6:

C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation: I_{CC(OPR)}=C_{PD}*V_{CC}*fin+I_{CC}*C_{PD} is used to determine the no-load dynamic power consumption; P_D=C_{PD}*V_{CC}²*fin+I_{CC}*V_{CC}*Fig.

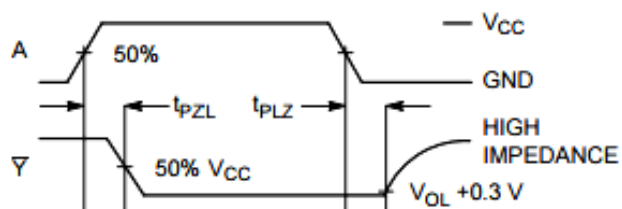


Figure 3. switching Waveforms

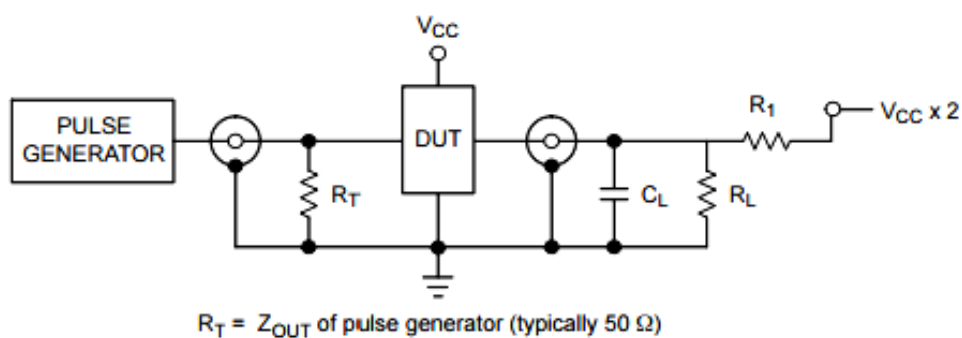
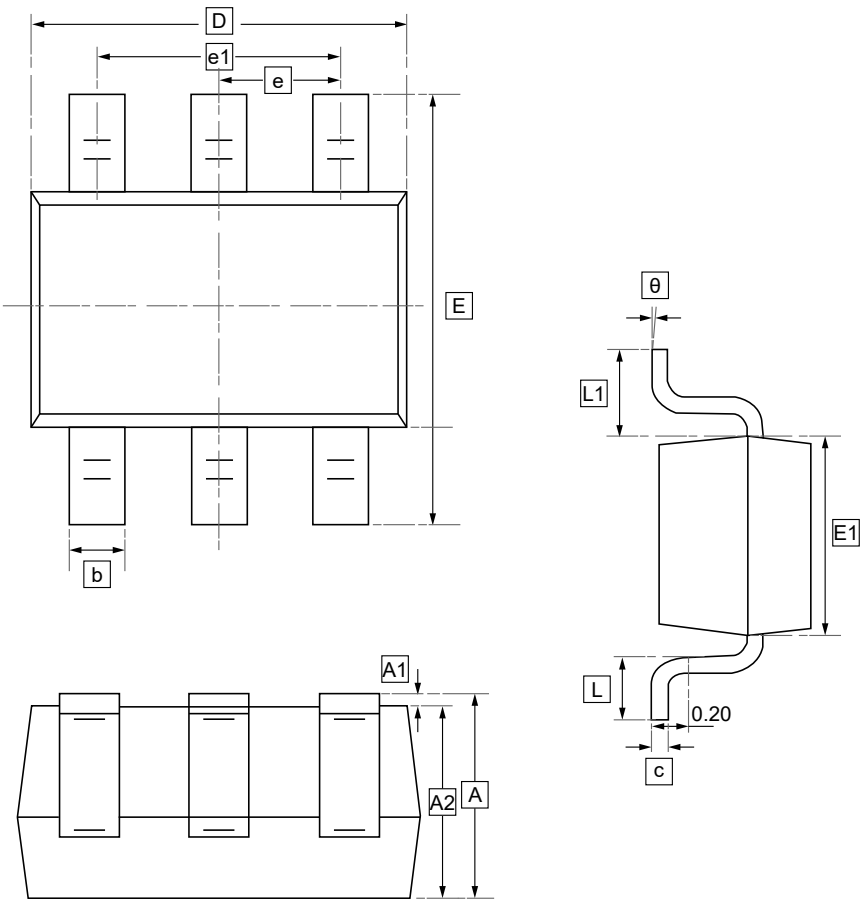


Figure 4. Test Circuit



11.1 SC70-6 Package Outline Dimensions



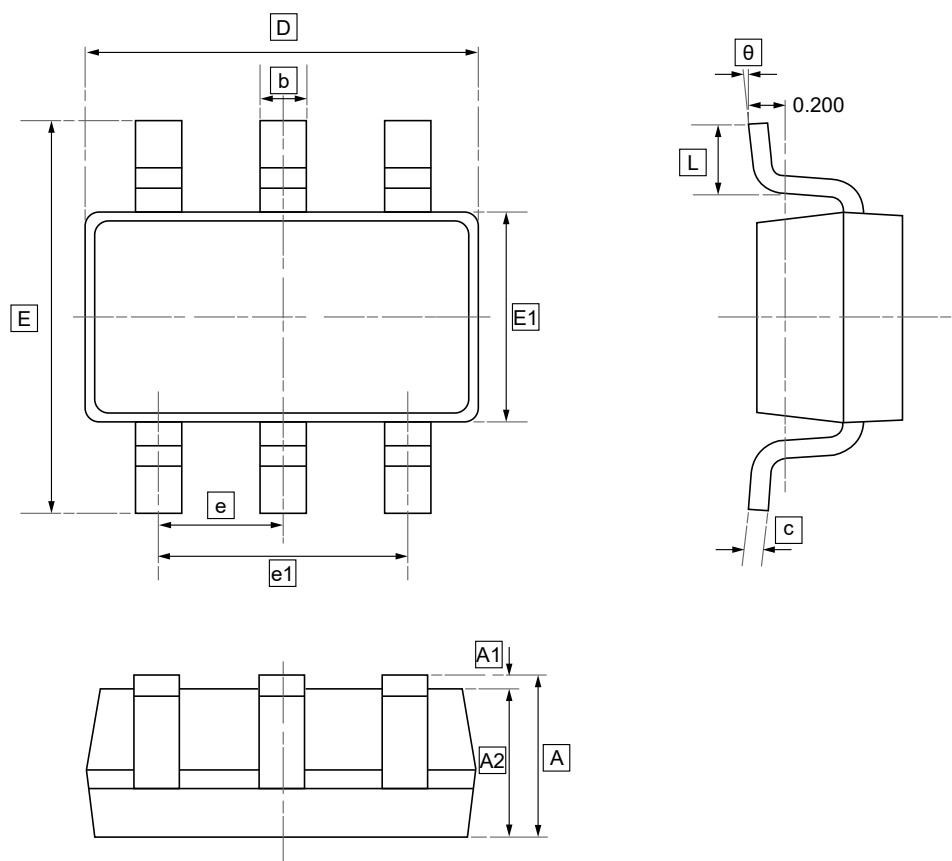
DIMENSIONS (mm are the original dimensions)

Symbol	A	A1	A2	b	c	D	E	E1	e	e1	L	L1
Min	0.90	0.00	0.90	0.15	0.08	2.05	2.15	1.15	0.65	1.2	0.26	0.525
Max	1.10	0.10	1.00	0.35	0.15	2.25	2.45	1.35	TYP.	1.4	0.46	REF.

Symbol	θ
Min	0°
Max	8°



11.2 SOT23-6 Package Outline Dimensions

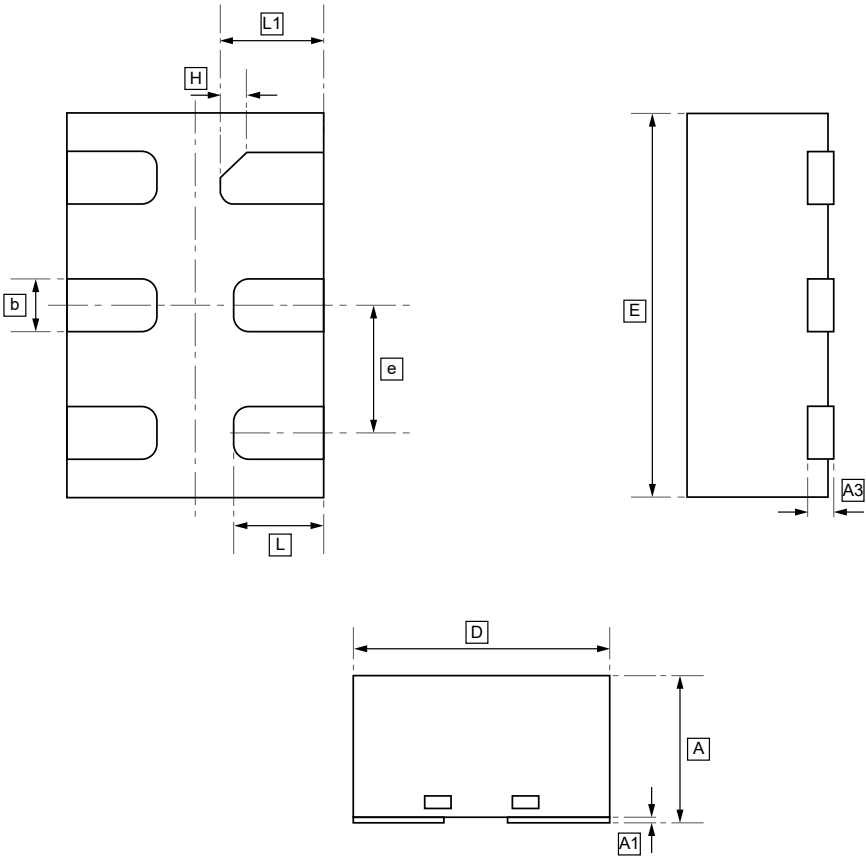


DIMENSIONS (mm are the original dimensions)

Symbol	A	A1	A2	b	c	D	E1	E	e	e1	L	θ
Min	1.050	0.000	1.050	0.300	0.100	2.820	1.500	2.650	0.950	1.800	0.300	0°
Max	1.250	0.100	1.150	0.500	0.200	3.020	1.700	2.950	BSC	2.000	0.600	8°



11.3 DFN6(1*1.5) Package Outline Dimensions

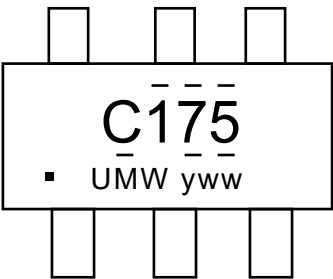


DIMENSIONS (mm are the original dimensions)

Symbol	A	A1	A3	b	D	E	e	H	L	L1
Min	0.50	0	0.10	0.15	0.90	1.40	0.40	0.10	0.30	0.35
Max	0.60	0.05	REF	0.25	1.10	1.60	0.60	REF	0.40	0.45



12.Ordering information



yww: Batch Code

Order Code	Marking	Package	Base QTY	Delivery Mode
UMW SN74LVC2G17DBVR	C175	SOT23-6	3000	Tape and reel
UMW SN74LVC2G17DCKR	C75	SC70-6	3000	Tape and reel
UMW SN74LVC2G17DRYR	C7	DFN6	5000	Tape and reel



13.Disclaimer

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